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"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

### Applications of "[Embedded - Microcontrollers](#)"

#### Details

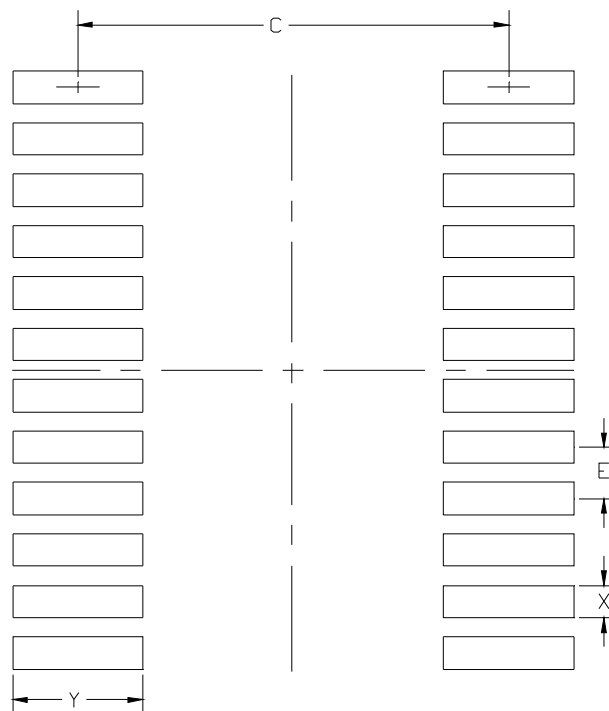
Product Status	Active
Core Processor	8051
Core Size	8-Bit
Speed	25MHz
Connectivity	I <sup>2</sup> C, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, POR, PWM, WDT
Number of I/O	15
Program Memory Size	4KB (4K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	512 x 8
Voltage - Supply (Vcc/Vdd)	2.2V ~ 3.6V
Data Converters	A/D 15x12b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	20-VQFN Exposed Pad
Supplier Device Package	-
Purchase URL	<a href="https://www.e-xfl.com/product-detail/silicon-labs/c8051f851-c-gmr">https://www.e-xfl.com/product-detail/silicon-labs/c8051f851-c-gmr</a>

**Table 1.7. ADC**

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Resolution	N <sub>bits</sub>	12 Bit Mode	12			Bits
		10 Bit Mode	10			Bits
Throughput Rate (High Speed Mode)	f <sub>S</sub>	12 Bit Mode	—	—	200	ksps
		10 Bit Mode	—	—	800	ksps
Throughput Rate (Low Power Mode)	f <sub>S</sub>	12 Bit Mode	—	—	62.5	ksps
		10 Bit Mode	—	—	250	ksps
Tracking Time	t <sub>TRK</sub>	High Speed Mode	230	—	—	ns
		Low Power Mode	450	—	—	ns
Power-On Time	t <sub>PWR</sub>		1.2	—	—	μs
SAR Clock Frequency	f <sub>SAR</sub>	High Speed Mode, Reference is 2.4 V internal	—	—	6.25	MHz
		High Speed Mode, Reference is not 2.4 V internal	—	—	12.5	MHz
		Low Power Mode	—	—	4	MHz
Conversion Time	t <sub>CNV</sub>	10-Bit Conversion, SAR Clock = 12.25 MHz, System Clock = 24.5 MHz.	1.1			μs
Sample/Hold Capacitor	C <sub>SAR</sub>	Gain = 1	—	5	—	pF
		Gain = 0.5	—	2.5	—	pF
Input Pin Capacitance	C <sub>IN</sub>		—	20	—	pF
Input Mux Impedance	R <sub>MUX</sub>		—	550	—	Ω
Voltage Reference Range	V <sub>REF</sub>		1	—	V <sub>DD</sub>	V
Input Voltage Range*	V <sub>IN</sub>	Gain = 1	0	—	V <sub>REF</sub>	V
		Gain = 0.5	0	—	2xV <sub>REF</sub>	V
Power Supply Rejection Ratio	PSRR <sub>ADC</sub>		—	70	—	dB
DC Performance						
Integral Nonlinearity	INL	12 Bit Mode	—	±1	±2.3	LSB
		10 Bit Mode	—	±0.2	±0.6	LSB
Differential Nonlinearity (Guaranteed Monotonic)	DNL	12 Bit Mode	–1	±0.7	1.9	LSB
		10 Bit Mode	—	±0.2	±0.6	LSB
*Note: Absolute input pin voltage is limited by the V <sub>DD</sub> supply.						

**Table 3.3. Pin Definitions for C8051F860/1/2/3/4/5-GS and C8051F860/1/2/3/4/5-IS**

<b>Pin Name</b>	<b>Type</b>	<b>Pin Numbers</b>	<b>Crossbar Capability</b>	<b>Additional Digital Functions</b>	<b>Analog Functions</b>
P0.1	Standard I/O	2	Yes	P0MAT.1 INT0.1 INT1.1	ADC0.1 CP0P.1 CP0N.1
P0.2	Standard I/O	1	Yes	P0MAT.2 INT0.2 INT1.2	ADC0.2 CP0P.2 CP0N.2
P0.3 / EXTCLK	Standard I/O / External CMOS Clock Input	16	Yes	P0MAT.3 EXTCLK INT0.3 INT1.3	ADC0.3 CP0P.3 CP0N.3
P0.4	Standard I/O	15	Yes	P0MAT.4 INT0.4 INT1.4	ADC0.4 CP0P.4 CP0N.4
P0.5	Standard I/O	14	Yes	P0MAT.5 INT0.5 INT1.5	ADC0.5 CP0P.5 CP0N.5
P0.6	Standard I/O	13	Yes	P0MAT.6 CNVSTR INT0.6 INT1.6	ADC0.6 CP1P.0 CP1N.0
P0.7	Standard I/O	12	Yes	P0MAT.7 INT0.7 INT1.7	ADC0.7 CP1P.1 CP1N.1
P1.0	Standard I/O	11	Yes	P1MAT.0	ADC0.8 CP1P.2 CP1N.2



**Figure 5.2. QSOP-24 PCB Land Pattern**

**Table 5.2. QSOP-24 PCB Land Pattern Dimensions**

Dimension	Min	Max
C	5.20	5.30
E	0.635 BSC	
X	0.30	0.40
Y	1.50	1.60

**Notes:**

**General**

1. All dimensions shown are in millimeters (mm) unless otherwise noted.
2. This land pattern design is based on the IPC-7351 guidelines.

**Solder Mask Design**

3. All metal pads are to be non-solder mask defined (NSMD). Clearance between the solder mask and the metal pad is to be 60  $\mu\text{m}$  minimum, all the way around the pad.

**Stencil Design**

4. A stainless steel, laser-cut and electro-polished stencil with trapezoidal walls should be used to assure good solder paste release.
5. The stencil thickness should be 0.125 mm (5 mils).
6. The ratio of stencil aperture to land pad size should be 1:1 for all perimeter pads.

**Card Assembly**

7. A No-Clean, Type-3 solder paste is recommended.
8. The recommended card reflow profile is per the JEDEC/IPC J-STD-020 specification for Small Body Components.

## 14.10. ADC Control Registers

### Register 14.1. ADC0CN0: ADC0 Control 0

Bit	7	6	5	4	3	2	1	0
Name	ADEN	ADBMEN	ADINT	ADBUSY	ADWINT	ADCM		
Type	RW	RW	RW	RW	RW	RW		
Reset	0	0	0	0	0	0	0	0

SFR Address: 0xE8 (bit-addressable)

Table 14.4. ADC0CN0 Register Bit Descriptions

Bit	Name	Function
7	ADEN	<b>Enable.</b> 0: ADC0 Disabled (low-power shutdown). 1: ADC0 Enabled (active and ready for data conversions).
6	ADBMEN	<b>Burst Mode Enable.</b> 0: ADC0 Burst Mode Disabled. 1: ADC0 Burst Mode Enabled.
5	ADINT	<b>Conversion Complete Interrupt Flag.</b> Set by hardware upon completion of a data conversion (ADBMEN=0), or a burst of conversions (ADBMEN=1). Can trigger an interrupt. Must be cleared by software.
4	ADBUSY	<b>ADC Busy.</b> Writing 1 to this bit initiates an ADC conversion when ADC0CM = 000. This bit should not be polled to indicate when a conversion is complete. Instead, the ADINT bit should be used when polling for conversion completion.
3	ADWINT	<b>Window Compare Interrupt Flag.</b> Set by hardware when the contents of ADC0H:ADC0L fall within the window specified by ADC0GTH:ADC0GTL and ADC0LTH:ADC0LTL. Can trigger an interrupt. Must be cleared by software.
2:0	ADCM	<b>Start of Conversion Mode Select.</b> Specifies the ADC0 start of conversion source. All remaining bit combinations are reserved. 000: ADC0 conversion initiated on write of 1 to ADBUSY. 001: ADC0 conversion initiated on overflow of Timer 0. 010: ADC0 conversion initiated on overflow of Timer 2. 011: ADC0 conversion initiated on overflow of Timer 3. 100: ADC0 conversion initiated on rising edge of CNVSTR. 101-111: Reserved.

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**Register 14.14. REF0CN: Voltage Reference Control**

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Bit	7	6	5	4	3	2	1	0
Name	IREFLVL	Reserved	GNDSL	REFSL		TEMPE	Reserved	
Type	RW	R	RW	RW		RW	R	
Reset	0	0	0	1	1	0	0	0

**SFR Address: 0xD1****Table 14.17. REF0CN Register Bit Descriptions**

Bit	Name	Function
7	IREFLVL	<b>Internal Voltage Reference Level.</b> Sets the voltage level for the internal reference source. 0: The internal reference operates at 1.65 V nominal. 1: The internal reference operates at 2.4 V nominal.
6	Reserved	Must write reset value.
5	GNDSL	<b>Analog Ground Reference.</b> Selects the ADC0 ground reference. 0: The ADC0 ground reference is the GND pin. 1: The ADC0 ground reference is the AGND pin.
4:3	REFSL	<b>Voltage Reference Select.</b> Selects the ADC0 voltage reference. 00: The ADC0 voltage reference is the VREF pin. 01: The ADC0 voltage reference is the VDD pin. 10: The ADC0 voltage reference is the internal 1.8 V digital supply voltage. 11: The ADC0 voltage reference is the internal voltage reference.
2	TEMPE	<b>Temperature Sensor Enable.</b> Enables/Disables the internal temperature sensor. 0: Temperature Sensor Disabled. 1: Temperature Sensor Enabled.
1:0	Reserved	Must write reset value.

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**Register 17.3. CPT0MX: Comparator 0 Multiplexer Selection**


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Bit	7	6	5	4	3	2	1	0
Name	CMXN				CMXP			
Type	RW				RW			
Reset	1	1	1	1	1	1	1	1

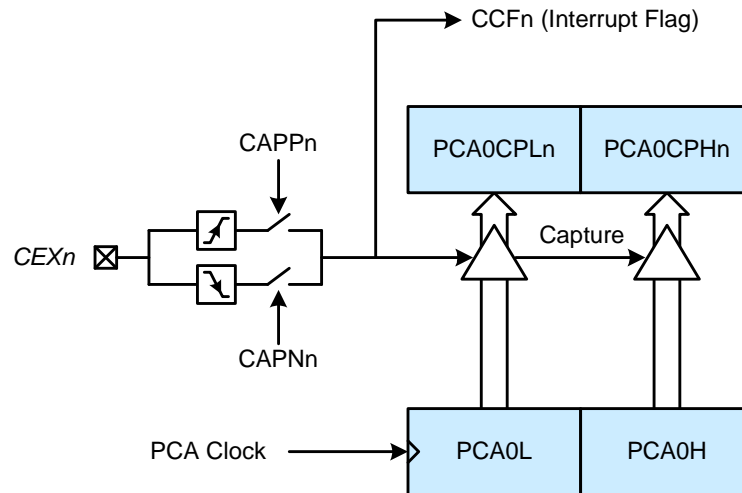
**SFR Address: 0x9F**

**Table 17.7. CPT0MX Register Bit Descriptions**

Bit	Name	Function
7:4	CMXN	<b>Comparator 0 Negative Input MUX Selection.</b> 0000: External pin CP0N.0 0001: External pin CP0N.1 0010: External pin CP0N.2 0011: External pin CP0N.3 0100: External pin CP0N.4 0101: External pin CP0N.5 0110: External pin CP0N.6 0111: External pin CP0N.7 1000: GND 1001-1111: Reserved.
3:0	CMXP	<b>Comparator 0 Positive Input MUX Selection.</b> 0000: External pin CP0P.0 0001: External pin CP0P.1 0010: External pin CP0P.2 0011: External pin CP0P.3 0100: External pin CP0P.4 0101: External pin CP0P.5 0110: External pin CP0P.6 0111: External pin CP0P.7 1000: Internal LDO output 1001-1111: Reserved.

### 20.3.2. Edge-Triggered Capture Mode

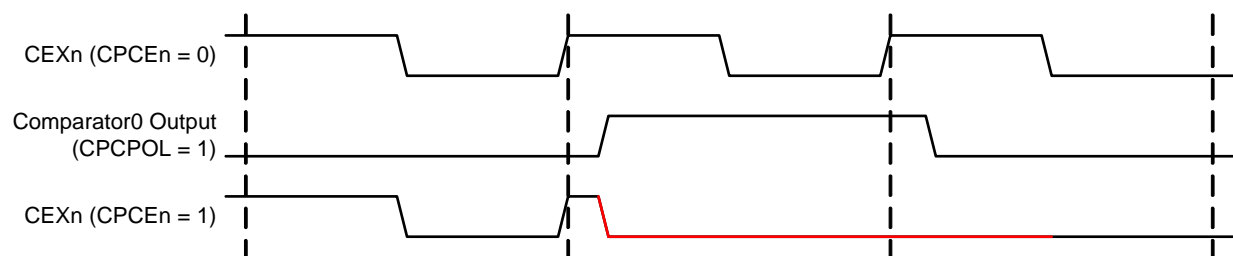
In this mode, a valid transition on the CEXn pin causes the PCA to capture the value of the PCA counter/timer and load it into the corresponding module's 16-bit capture/compare register (PCA0CPLn and PCA0CPHn). The CAPPn and CAPNn bits in the PCA0CPMn register are used to select the type of transition that triggers the capture: low-to-high transition (positive edge), high-to-low transition (negative edge), or either transition (positive or negative edge). When a capture occurs, the Capture/Compare Flag (CCFn) in PCA0CN is set to logic 1. An interrupt request is generated if the CCFn interrupt for that module is enabled. The CCFn bit is not automatically cleared by hardware when the CPU vectors to the interrupt service routine, and must be cleared by software. If both CAPPn and CAPNn bits are set to logic 1, then the state of the Port pin associated with CEXn can be read directly to determine whether a rising-edge or falling-edge caused the capture.



**Figure 20.2. PCA Capture Mode Diagram**

**Note:** The CEXn input signal must remain high or low for at least 2 system clock cycles to be recognized by the hardware.





**Figure 20.11. CEXn with CPCEn = 1, CPCPOL = 1**

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**Register 21.5. P0MASK: Port 0 Mask**

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Bit	7	6	5	4	3	2	1	0
Name	P0MASK							
Type	RW							
Reset	0	0	0	0	0	0	0	0
SFR Address: 0xFE								

**Table 21.8. P0MASK Register Bit Descriptions**

Bit	Name	Function
7:0	P0MASK	<b>Port 0 Mask Value.</b> Selects P0 pins to be compared to the corresponding bits in P0MAT. 0: P0.x pin logic value is ignored and will cause a port mismatch event. 1: P0.x pin logic value is compared to P0MAT.x.

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**Register 21.6. P0MAT: Port 0 Match**

---

Bit	7	6	5	4	3	2	1	0
Name	P0MAT							
Type	RW							
Reset	1	1	1	1	1	1	1	1
SFR Address: 0xFD								

**Table 21.9. P0MAT Register Bit Descriptions**

Bit	Name	Function
7:0	P0MAT	<b>Port 0 Match Value.</b> Match comparison value used on P0 pins for bits in P0MASK which are set to 1. 0: P0.x pin logic value is compared with logic LOW. 1: P0.x pin logic value is compared with logic HIGH.

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**Register 21.16. P1SKIP: Port 1 Skip**

---

Bit	7	6	5	4	3	2	1	0
Name	P1SKIP							
Type	RW							
Reset	0	0	0	0	0	0	0	0
<b>SFR Address: 0xD5</b>								

**Table 21.19. P1SKIP Register Bit Descriptions**

Bit	Name	Function
7:0	P1SKIP	<b>Port 1 Skip.</b> These bits select port pins to be skipped by the crossbar decoder. Port pins used for analog, special functions or GPIO should be skipped. 0: Corresponding P1.x pin is not skipped by the crossbar. 1: Corresponding P1.x pin is skipped by the crossbar.
<b>Note:</b> Port 1 consists of 8 bits (P1.0-P1.7) on QSOP24 packages and 7 bits (P1.0-P1.6) on QFN20 packages and 4 bits (P1.0-P1.3) on SOIC16 packages.		

## 22. Reset Sources and Supply Monitor

Reset circuitry allows the controller to be easily placed in a predefined default condition. Upon entering this reset state, the following events occur:

- CIP-51 halts program execution
- Special Function Registers (SFRs) are initialized to their defined reset values
- External port pins are placed in a known state
- Interrupts and timers are disabled.

All SFRs are reset to the predefined values noted in the SFR detailed descriptions. The contents of internal data memory are unaffected during a reset; any previously stored data is preserved. However, since the stack pointer SFR is reset, the stack is effectively lost, even though the data on the stack is not altered.

The Port I/O latches are reset to 0xFF (all logic ones) in open-drain, low-drive mode. Weak pullups are enabled during and after the reset. For  $V_{DD}$  Monitor and power-on resets, the  $\overline{RST}$  pin is driven low until the device exits the reset state. Note that during a power-on event, there may be a short delay before the POR circuitry fires and the  $\overline{RST}$  pin is driven low. During that time, the  $\overline{RST}$  pin will be weakly pulled to the  $V_{DD}$  supply pin.

On exit from the reset state, the program counter (PC) is reset, the Watchdog Timer is enabled and the system clock defaults to the internal oscillator. Program execution begins at location 0x0000.

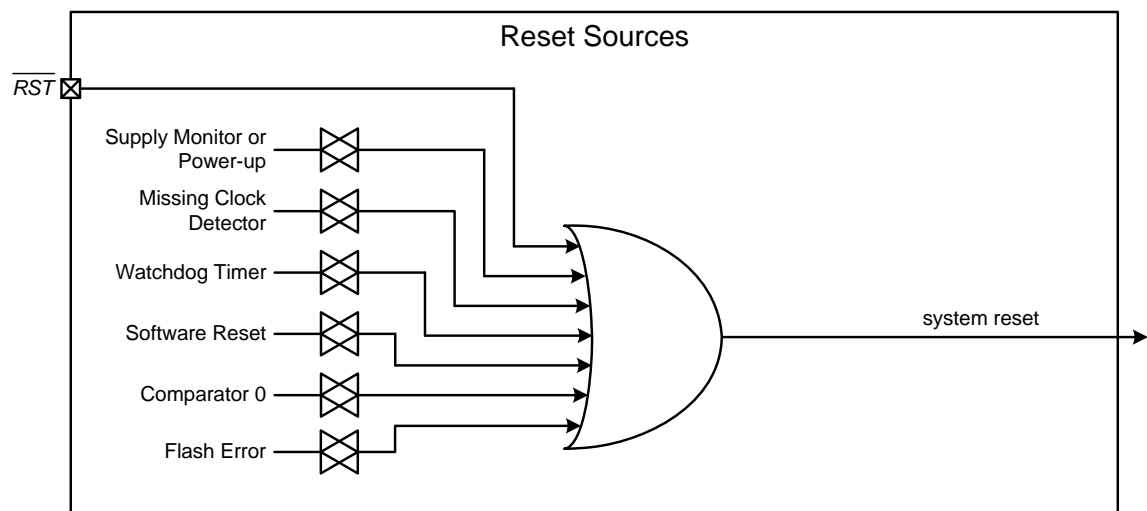


Figure 22.1. Reset Sources

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**Table 24.7. SMB0CF Register Bit Descriptions**

Bit	Name	Function
1:0	SMBCS	<b>SMBus0 Clock Source Selection.</b> These two bits select the SMBus0 clock source, which is used to generate the SMBus0 bit rate. See the SMBus clock timing section for additional details. 00: Timer 0 Overflow 01: Timer 1 Overflow 10: Timer 2 High Byte Overflow 11: Timer 2 Low Byte Overflow

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## 25.1. Timer 0 and Timer 1

Timer 0 and Timer 1 are each implemented as a 16-bit register accessed as two separate bytes: a low byte (TL0 or TL1) and a high byte (TH0 or TH1). The Counter/Timer Control register (TCON) is used to enable Timer 0 and Timer 1 as well as indicate status. Timer 0 interrupts can be enabled by setting the ET0 bit in the IE register. Timer 1 interrupts can be enabled by setting the ET1 bit in the IE register. Both counter/timers operate in one of four primary modes selected by setting the Mode Select bits T1M1–T0M0 in the Counter/Timer Mode register (TMOD). Each timer can be configured independently for the operating modes described below.

### 25.1.1. Mode 0: 13-bit Counter/Timer

Timer 0 and Timer 1 operate as 13-bit counter/timers in Mode 0. The following describes the configuration and operation of Timer 0. However, both timers operate identically, and Timer 1 is configured in the same manner as described for Timer 0.

The TH0 register holds the eight MSBs of the 13-bit counter/timer. TL0 holds the five LSBs in bit positions TL0.4–TL0.0. The three upper bits of TL0 (TL0.7–TL0.5) are indeterminate and should be masked out or ignored when reading. As the 13-bit timer register increments and overflows from 0x1FFF (all ones) to 0x0000, the timer overflow flag TF0 in TCON is set and an interrupt will occur if Timer 0 interrupts are enabled.

The CT0 bit in the TMOD register selects the counter/timer's clock source. When CT0 is set to logic 1, high-to-low transitions at the selected Timer 0 input pin (T0) increment the timer register. Clearing CT0 selects the clock defined by the T0M bit in register CKCON. When T0M is set, Timer 0 is clocked by the system clock. When T0M is cleared, Timer 0 is clocked by the source selected by the Clock Scale bits in CKCON.

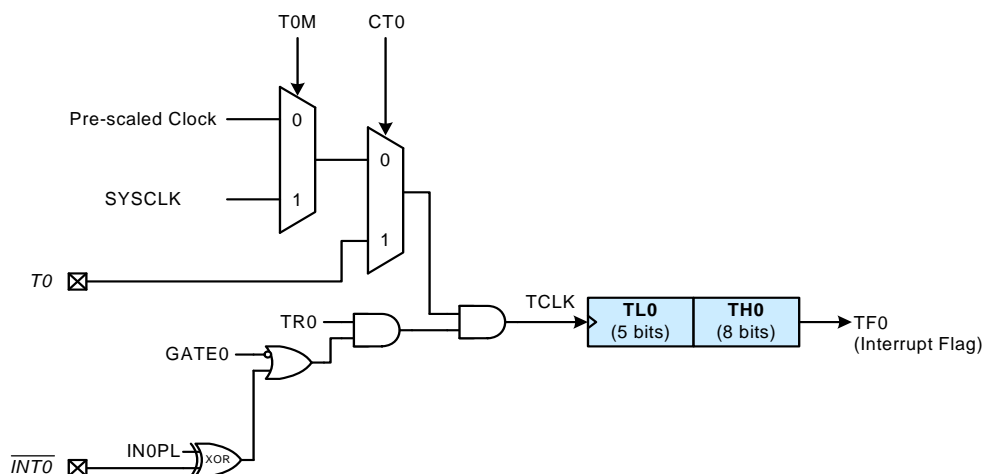
Setting the TR0 bit enables the timer when either GATE0 in the TMOD register is logic 0 or the input signal  $\overline{\text{INT0}}$  is active as defined by bit IN0PL in register IT01CF. Setting GATE0 to 1 allows the timer to be controlled by the external input signal  $\overline{\text{INT0}}$ , facilitating pulse width measurements.

TR0	GATE0	$\overline{\text{INT0}}$	Counter/Timer
0	X	X	Disabled
1	0	X	Enabled
1	1	0	Disabled
1	1	1	Enabled

**Note:** X = Don't Care

Setting TR0 does not force the timer to reset. The timer registers should be loaded with the desired initial value before the timer is enabled.

TL1 and TH1 form the 13-bit register for Timer 1 in the same manner as described above for TL0 and TH0. Timer 1 is configured and controlled using the relevant TCON and TMOD bits just as with Timer 0. The input signal INT1 is used with Timer 1; the  $\overline{\text{INT1}}$  polarity is defined by bit IN1PL in register IT01CF.



**Figure 25.1. T0 Mode 0 Block Diagram**



#### 25.1.4. Mode 3: Two 8-bit Counter/Timers (Timer 0 Only)

In Mode 3, Timer 0 is configured as two separate 8-bit counter/timers held in TL0 and TH0. The counter/timer in TL0 is controlled using the Timer 0 control/status bits in TCON and TMOD: TR0, CT0, GATE0 and TF0. TL0 can use either the system clock or an external input signal as its timebase. The TH0 register is restricted to a timer function sourced by the system clock or prescaled clock. TH0 is enabled using the Timer 1 run control bit TR1. TH0 sets the Timer 1 overflow flag TF1 on overflow and thus controls the Timer 1 interrupt.

Timer 1 is inactive in Mode 3. When Timer 0 is operating in Mode 3, Timer 1 can be operated in Modes 0, 1 or 2, but cannot be clocked by external signals nor set the TF1 flag and generate an interrupt. However, the Timer 1 overflow can be used to generate baud rates for the SMBus and/or UART, and/or initiate ADC conversions. While Timer 0 is operating in Mode 3, Timer 1 run control is handled through its mode settings. To run Timer 1 while Timer 0 is in Mode 3, set the Timer 1 Mode as 0, 1, or 2. To disable Timer 1, configure it for Mode 3.

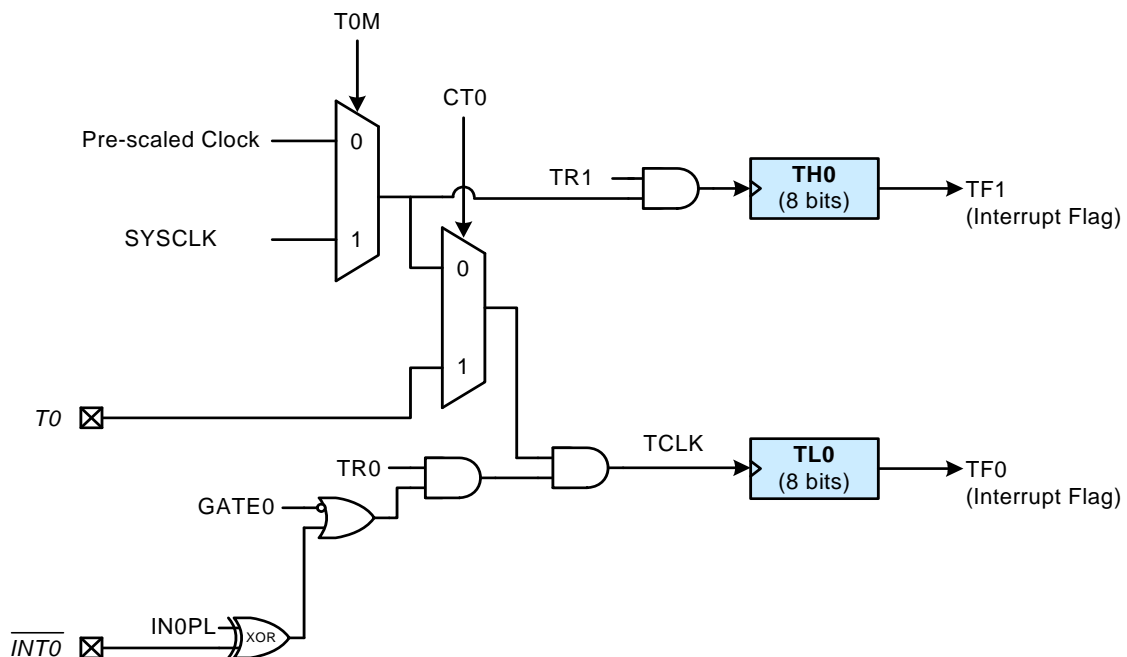


Figure 25.3. T0 Mode 3 Block Diagram

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**Table 25.3. CKCON Register Bit Descriptions**

Bit	Name	Function
1:0	SCA	<b>Timer 0/1 Prescale Bits.</b> These bits control the Timer 0/1 Clock Prescaler: 00: System clock divided by 12 01: System clock divided by 4 10: System clock divided by 48 11: External clock divided by 8 (synchronized with the system clock)

**Table 26.1. Timer Settings for Standard Baud Rates Using the Internal 24.5 MHz Oscillator**

Frequency: 49 MHz							
	Target Baud Rate (bps)	Baud Rate % Error	Oscillator Divide Factor	Timer Clock Source	SCA1–SCA0 (pre-scale select) <sup>1</sup>	T1M <sup>1</sup>	Timer 1 Reload Value (hex)
SYSCLK from Internal Osc.	230400	–0.32%	106	SYSCLK	XX <sup>2</sup>	1	0xCB
	115200	–0.32%	212	SYSCLK	XX	1	0x96
	57600	0.15%	426	SYSCLK	XX	1	0x2B
	28800	–0.32%	848	SYSCLK/4	01	0	0x96
	14400	0.15%	1704	SYSCLK/12	00	0	0xB9
	9600	–0.32%	2544	SYSCLK/12	00	0	0x96
	2400	–0.32%	10176	SYSCLK/48	10	0	0x96
	1200	0.15%	20448	SYSCLK/48	10	0	0x2B
<b>Notes:</b> <ol style="list-style-type: none"> <li>1. SCA1–SCA0 and T1M bit definitions can be found in Timer1 chapter.</li> <li>2. X = Don't care.</li> </ol>							

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## 28. Revision-Specific Behavior

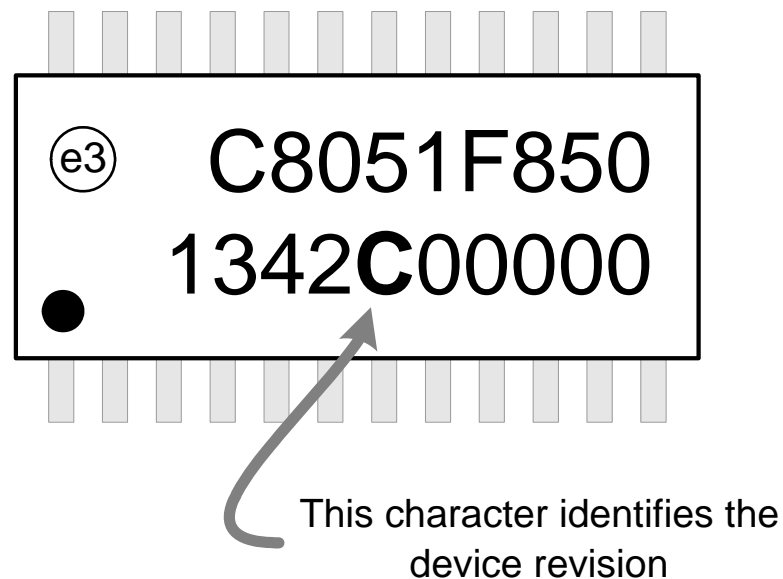
C8051F85x/86x Revision B devices have differences from Revision C devices:

- Temperature Sensor offset and slope
- Flash endurance
- Latch-up performance
- Unique Identifier

### 28.1. Revision Identification

The Lot ID Code on the top side of the device package can be used for decoding device revision information. Figure 28.1, Figure 28.2, and Figure 28.3 show how to find the Lot ID Code on the top side of the device package.

Firmware can distinguish between a Revision B and Revision C device using the value of the REVID register described in “Device Identification and Unique Identifier” on page 68.



**Figure 28.1. QSOP-24 Package Revision Marking**

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## 29.2. C2 Interface Registers

The following describes the C2 registers necessary to perform flash programming through the C2 interface. All C2 registers are accessed through the C2 interface, and are not available in the SFR map for firmware access.

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### Register 29.1. C2ADD: C2 Address

---

Bit	7	6	5	4	3	2	1	0
Name	C2ADD							
Type	RW							
Reset	0	0	0	0	0	0	0	0

This register is part of the C2 protocol.

**Table 29.1. C2ADD Register Bit Descriptions**

Bit	Name	Function
7:0	C2ADD	<b>C2 Address.</b> The C2ADD register is accessed via the C2 interface. The value written to C2ADD selects the target data register for C2 Data Read and Data Write commands. 0x00: C2DEVID 0x01: C2REVID 0x02: C2FPCTL 0xB4: C2FPDAT